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(12) **United States Design Patent**
Brennwald

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(54) **HEADSET**

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(73) Assignee: **Sennheiser electronic GmbH & Co. KG**, Wedemark (DE)

(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (8) Cl.** **14-01**

(52) **U.S. Cl.** **D14/224**

(58) **Field of Classification Search** D14/149,
D14/155, 205–206, 217, 223, 224, 251, 253,
D14/229, 137; D13/107–108; D16/242;
320/113; 379/430–431, 446–447, 450, 454,
379/455; 455/569.1

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D307,016 S *	4/1990	Watanabe	D14/240
D322,068 S *	12/1991	Yamakawa	D14/168
D328,276 S *	7/1992	Koinuma	D13/107
D329,221 S *	9/1992	Khoo	D13/107
D355,913 S *	2/1995	Chong	D14/168
D357,016 S *	4/1995	Li et al.	D14/168
D390,553 S *	2/1998	Beaumont et al.	D14/137
D400,165 S *	10/1998	Nagele et al.	D13/108
6,229,893 B1 *	5/2001	Chen	379/454

D462,337 S *	9/2002	Schmidt et al.	D14/149
D462,342 S *	9/2002	Polito et al.	D14/224
D496,029 S *	9/2004	Skulley et al.	D14/224
D513,404 S *	1/2006	Lodato et al.	D13/108
D518,477 S *	4/2006	Chen	D14/253
D520,946 S *	5/2006	Nasu	D13/108
D528,979 S *	9/2006	Franck et al.	D13/108
D532,005 S *	11/2006	Leith	D14/253
D551,216 S *	9/2007	Wei	D14/223

* cited by examiner

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(57) **CLAIM**

The ornamental design for headset, as shown and described.

DESCRIPTION

FIG. 1 is a three-dimensional top view of the headset in accordance with the invention;

FIG. 2 is a three-dimensional bottom view of the headset in accordance with the invention;

FIG. 3 is a three-dimensional front view of the headset in accordance with the invention;

FIG. 4 is an isometric view of the headset in accordance with the invention;

FIG. 5 is a three-dimensional right side view of the headset in accordance with the invention;

FIG. 6 is a three-dimensional left side view of the headset in accordance with the invention; and,

FIG. 7 is a three-dimensional back view of the headset in accordance with the invention.

1 Claim, 7 Drawing Sheets

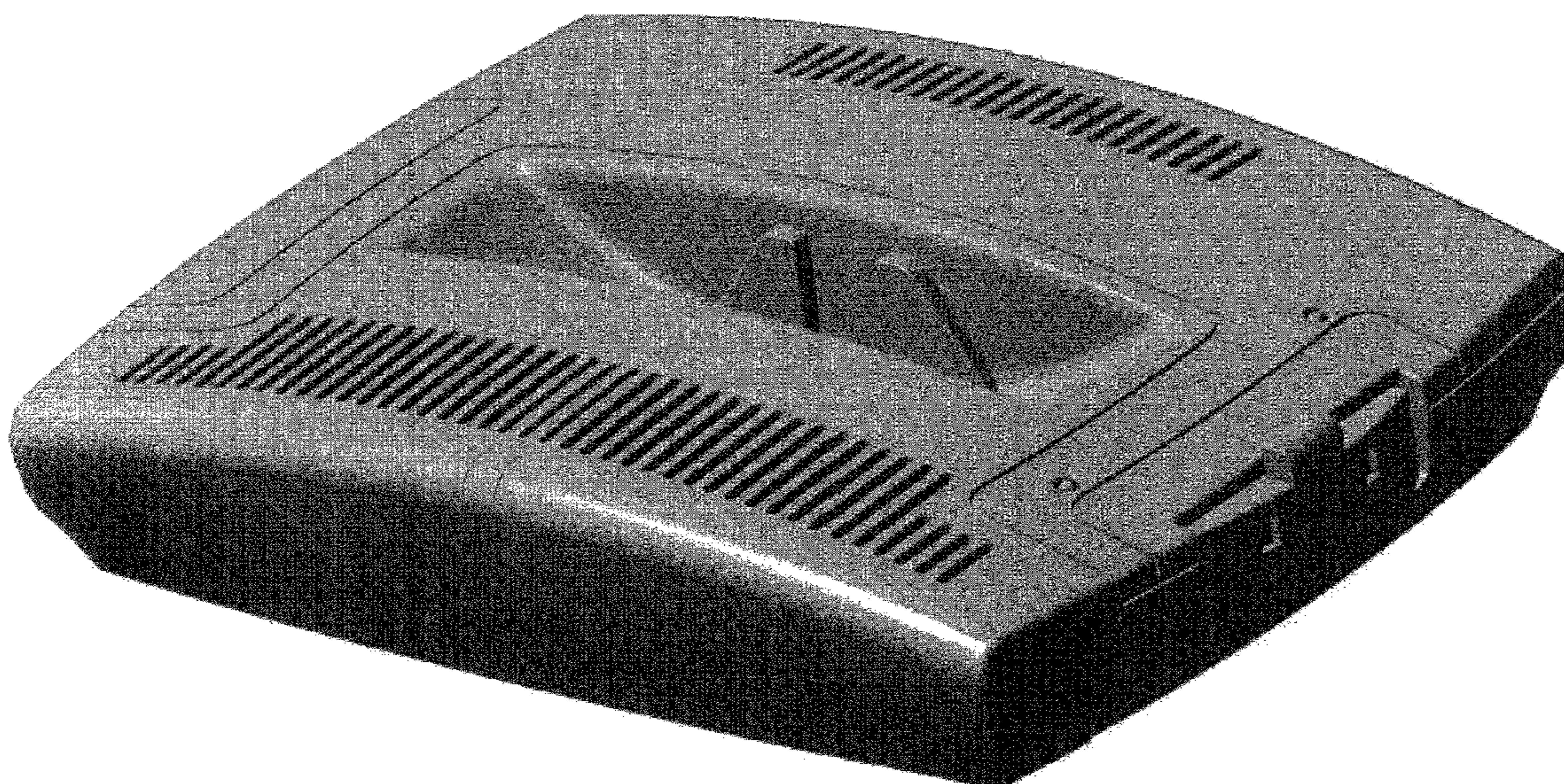
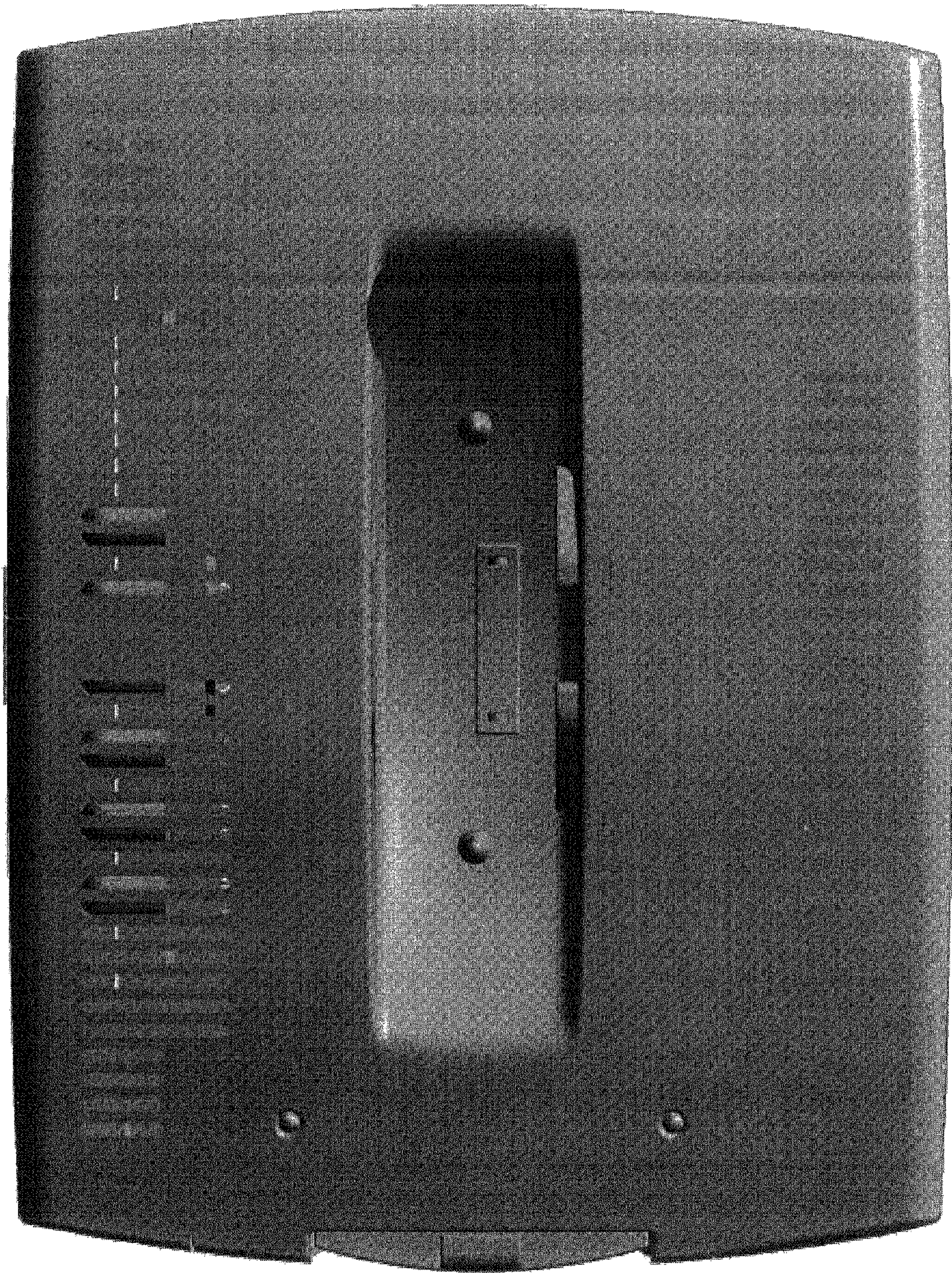


FIG. 1



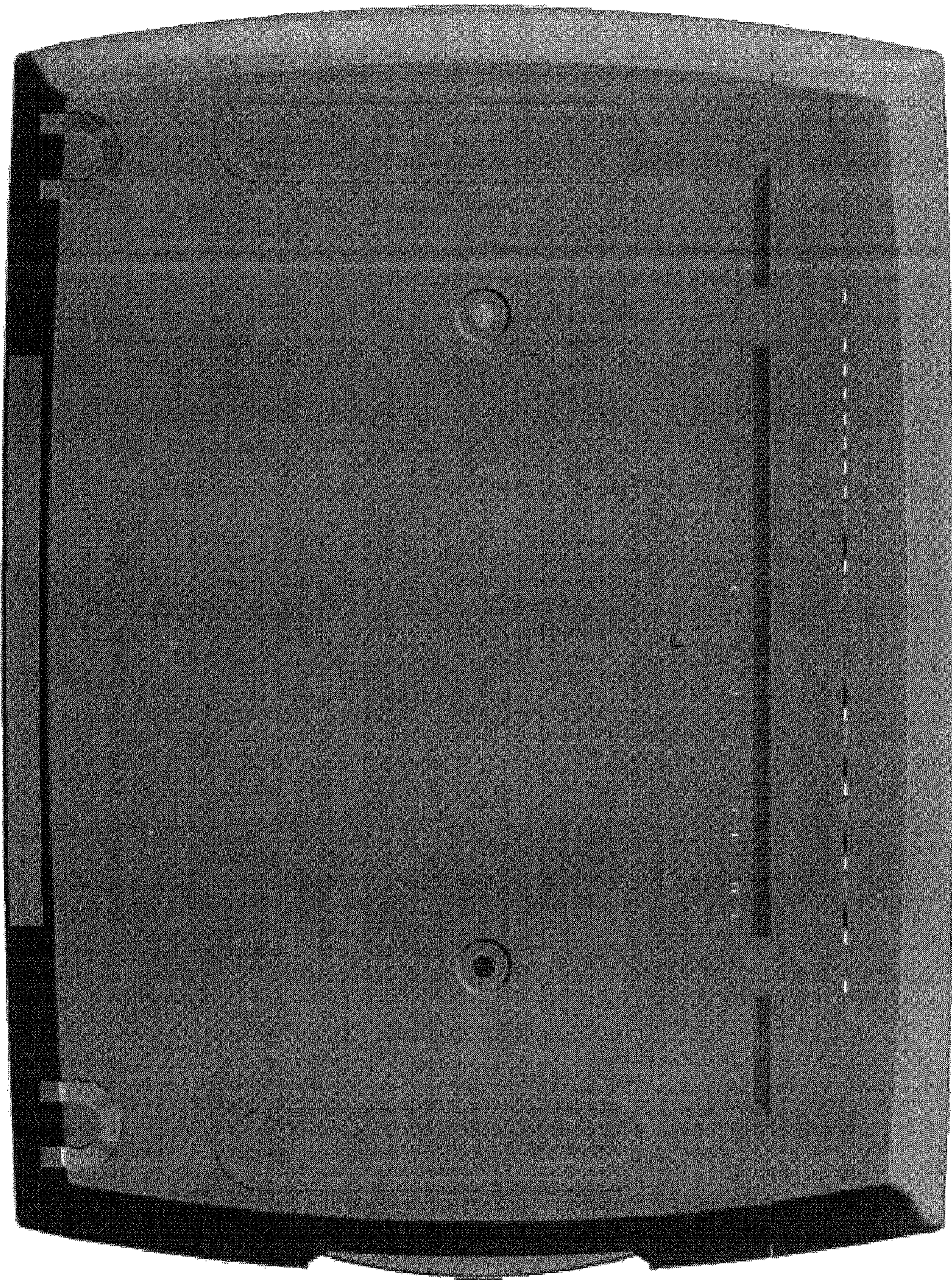


FIG. 2

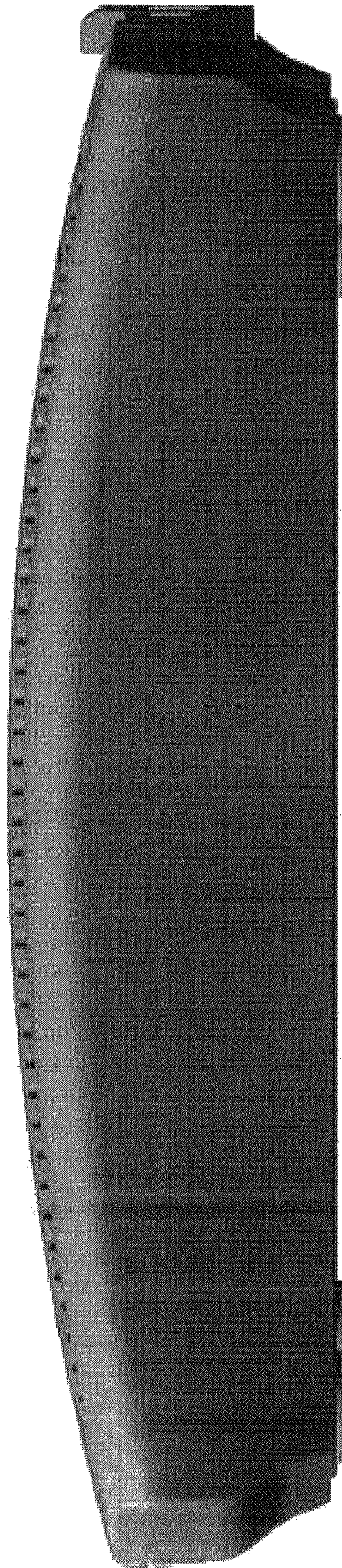


FIG. 3

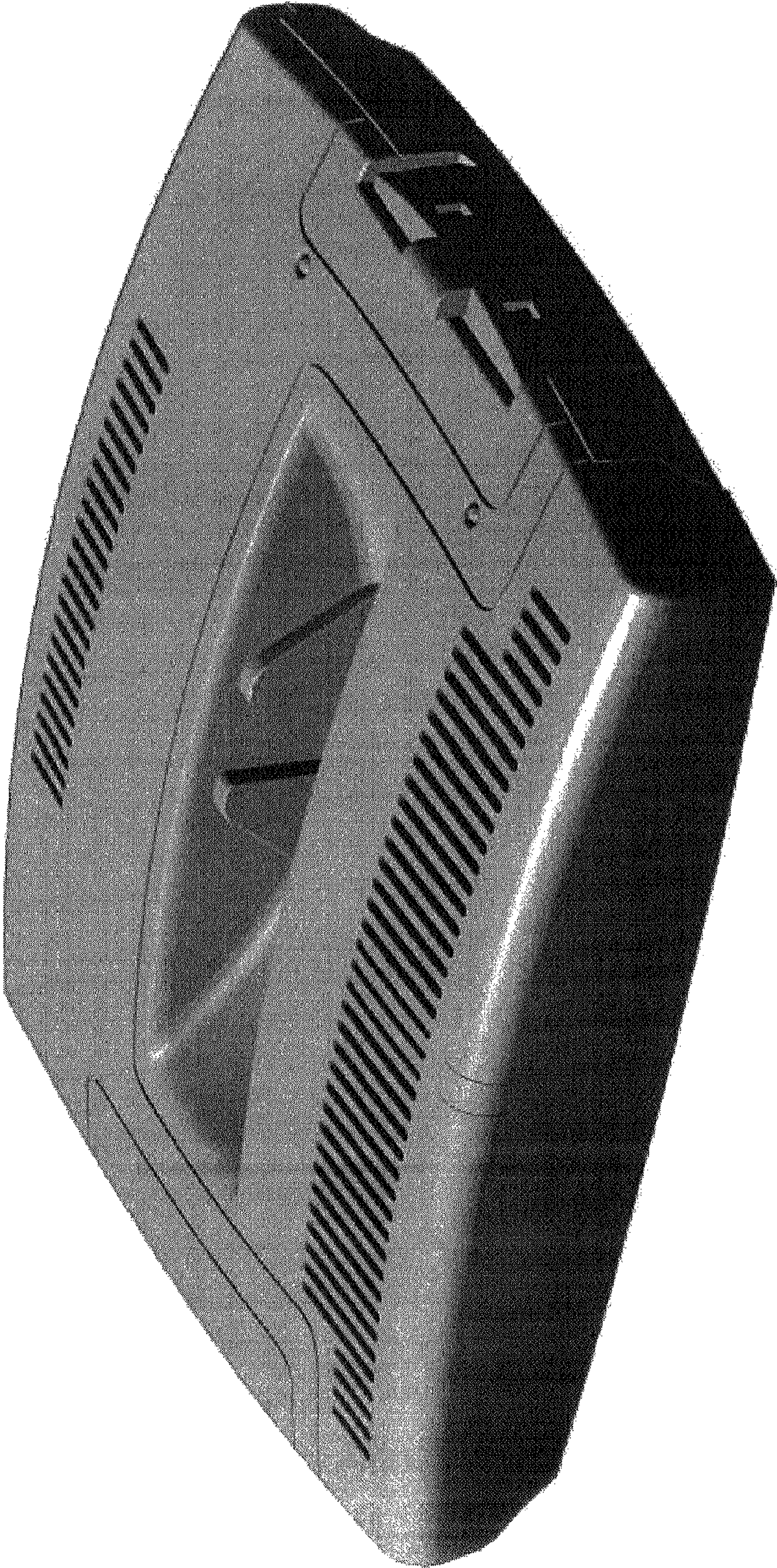


FIG. 4



FIG. 5

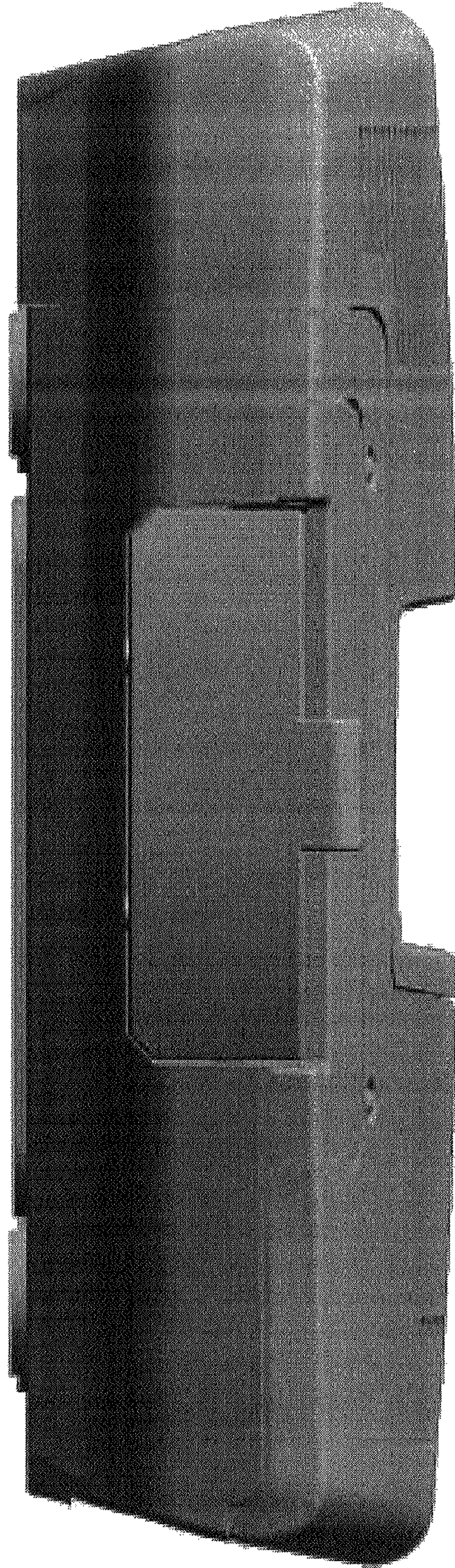


FIG. 6

FIG. 7

